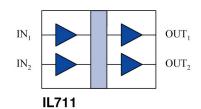
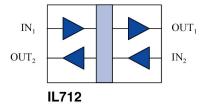


# High Speed Dual Digital Isolator

#### **Functional Diagram**





#### **Features**

- +5 V/+3.3 V CMOS / TTL Compatible
- High Speed: 110 Mbps
- 2500 V<sub>RMS</sub> Isolation (1 min.)
- 2 ns Typical Pulse Width Distortion
- 4 ns Typical Propagation Delay Skew
- 10 ns Typical Propagation Delay
- 30 kV/µs Typical Common Mode Transient Immunity
- 2 ns Channel-to-Channel Skew
- 8-pin PDIP and 8-pin SOIC Packages
- UL1577 Approved (File # E207481)
- IEC 61010-1 Approved (Report # 607057)

#### **Applications**

- ADCs and DACs
- Digital Fieldbus
- RS485 and RS422
- · Multiplexed Data Transmission
- Data Interfaces
- · Board-to-Board Communication
- Digital Noise Reduction
- Operator Interface
- Ground Loop Elimination
- Peripheral Interfaces
- Serial Communication
- Logic Level Shifting

#### **Description**

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NVE's family of high-speed digital isolators are CMOS devices created by integrating active circuitry and our GMR-based and patented\* IsoLoop® technology. The IL711 and IL712 are two-channel versions of the world's fastest digital isolator with a 110 Mbps data rate. These devices offer true isolated logic integration not previously available. All transmit and receive channels operate at 110 Mbps over the full temperature and supply voltage range. The symmetric magnetic coupling barrier provides a typical propagation delay of only 10 ns and a pulse width distortion of 2 ns, achieving the best specifications of any isolator device. Typical transient immunity of 30 kV/ $\mu$ s is unsurpassed. The IL711 has two transmit channels; the IL712 has one transmit channel and one receive channel. The IL712 operates in full duplex mode making it ideal for many field bus applications including PROFIBUS.

The IL711 and IL712 are available in 8-pin PDIP and 8-pin SOIC packages and performance is specified over the temperature range of -40°C to +100°C without derating. The T-Series parts (-40°C to +125°C) offer the user the widest temperature range digital couplers available.

IsoLoop is a registered trademark of NVE Corporation. \*U.S. Patent numbers 5,831,426; 6,300,617 and others.

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# IL711 IL712

Absolute Maximum Ratings(1)

Parameters	Symbol	Min.	Тур.	Max.	Units	<b>Test Conditions</b>
Storage Temperature	$T_{s}$	-55		150	°C	
Ambient Operating Temperature T-Series	$T_{A}$	-55		125 135	°C	
Supply Voltage	$V_{DD1}, V_{DD2}$	-0.5		7	V	
Input Voltage	$V_{\rm I}$	-0.5		$V_{DD} + 0.5$	V	
Output Voltage	$V_{o}$	-0.5		$V_{DD} + 0.5$	V	
Output Current Drive	$I_{o}$			10	mA	
Lead Solder Temperature				260	°C	10 sec.
ESD			2		kV	HBM

**Recommended Operating Conditions** 

Parameters	Symbol	Min.	Тур.	Max.	Units	<b>Test Conditions</b>
Ambient Operating Temperature	т	-40		100	°C	
T-Series	1 A	-40		125	C	
Supply Voltage	$V_{DD1}, V_{DD2}$	3.0		5.5	V	
Logic High Input Voltage	$V_{\text{IH}}$	2.4		$V_{\scriptscriptstyle  m DD}$	V	
Logic Low Input Voltage	$V_{\scriptscriptstyle \mathrm{IL}}$	0		0.8	V	
Input Signal Rise and Fall Times	$t_{IR}, t_{IF}$			1	μs	

**Insulation Specifications** 

Parameters	`	Symbol	Min.	Тур.	Max.	Units	<b>Test Conditions</b>
Creepage Distance							
SOIC			4.026			mm	
PDIP			7.036			mm	
Leakage Current				0.2		μΑ	240 V <sub>RMS</sub> , 60 Hz
Barrier Impedance		M Doi	08h	>10 <sup>14</sup>   3		$\Omega \parallel pF$	
	VV VV I	W.Dai	laoi	CCL	FU.U	UIII	

Package Characteristics

r donago orial dotoriotico						
Parameters	Symbol	Min.	Typ.	Max.	Units	Test Conditions
Capacitance (Input-Output) <sup>(5)</sup>	$C_{\text{I-O}}$		2		pF	f = 1  MHz
Thermal Resistance						
SOIC	$\theta_{ ext{\tiny JCT}}$		240		°C/W	Thermocouple at center
PDIP	$\theta_{ ext{\tiny JCT}}$		150		°C/W	underside of package
Package Power Dissipation	$P_{PD}$			150	mW	$f = 1 \text{ MHz}, V_{DD} = 5 \text{ V}$

### Safety & Approvals

### IEC61010-1

TUV Certificate Numbers: SOIC B 01 07 44230 002 PDIP B 01 07 44230 001

## **Classification: Reinforced Insulation**

		Pollution	Material	Max. Working
Model	Package	Degree	Group	Voltage
IL711-2, IL712-2	PDIP	II	III	$300 V_{RMS}$
IL711-3, IL712-3	SOIC	II	III	$150 V_{RMS}$

### **UL 1577**

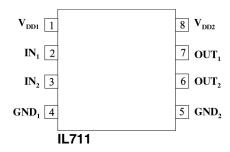
Component Recognition program File #: E207481 Rated  $2500V_{\scriptscriptstyle RMS}$  for 1 minute





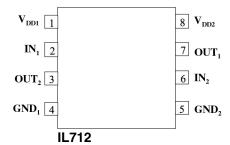
#### **IL711 Pin Connections**

1	$V_{\mathrm{DD1}}$	Supply voltage
2	$IN_1$	Data in, channel 1
3	$IN_2$	Data in, channel 2
4	$GND_1$	Ground return for V <sub>DD1</sub>
5	$GND_2$	Ground return for V <sub>DD2</sub>
6	$OUT_2$	Data out, channel 2
7	$OUT_1$	Data out, channel 1
8	$V_{\mathrm{DD2}}$	Supply voltage



### **IL712 Pin Connections**

1	$V_{\mathrm{DD1}}$	Supply voltage
2	$IN_1$	Data in, channel 1
3	OUT <sub>2</sub>	Data out, channel 2
4	$GND_1$	Ground return for V <sub>DD1</sub>
5	$GND_2$	Ground return for V <sub>DD2</sub>
6	$IN_2$	Data in, channel 2
7	$OUT_1$	Data out, channel 1
8	$V_{\mathrm{DD2}}$	Supply voltage

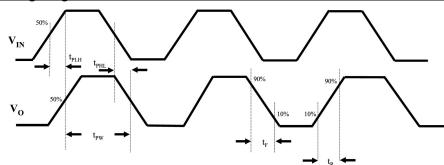


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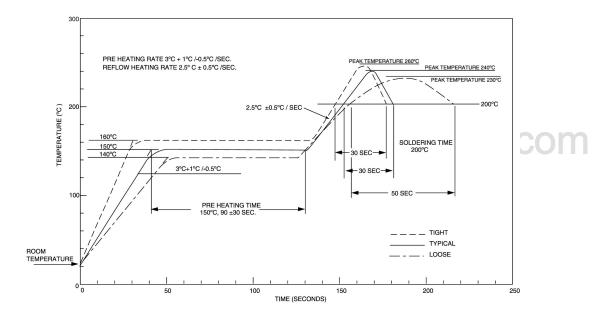
## **Timing Diagram**



## Legend

$t_{\rm PLH}$	Propagation Delay, Low to High
$t_{ m PHL}$	Propagation Delay, High to Low
$t_{\mathrm{PW}}$	Minimum Pulse Width
$t_{\rm R}$	Rise Time
$t_{\scriptscriptstyle \mathrm{F}}$	Fall Time

## IR Soldering Profile







# 3.3 Volt Electrical Specifications

Electrical specifications are T<sub>min</sub> to T<sub>max</sub> unless otherwise stated.

Parameters	Symbol	Min.	Тур.	Max.	Units	<b>Test Conditions</b>
		DC Specific	cations			
Input Quiescent Supply Voltage						
IL711	ī		8	10	μΑ	
IL712	$I_{\mathrm{DD1}}$		1.5	2	mA	
Output Quiescent Supply Voltage						
IL711	$I_{\mathrm{DD2}}$		3.3	4	mA	
IL712	1 <sub>DD2</sub>		1.5	2	mA	
Logic Input Current	$I_{\rm I}$	-10		10	μΑ	
Logic High Output Voltage	$V_{\mathrm{OH}}$	V <sub>DD</sub> - 0.1	$V_{ m DD}$		V	$I_{O} = -20 \mu\text{A},  V_{I} = V_{IH}$
Logic High Output Vollage	V OH	$0.8 \times V_{DD}$	$0.9 \times V_{DD}$		·	$I_O = -4 \text{ mA}, V_I = V_{IH}$
Logic Low Output Voltage	$V_{ m OL}$		0	0.1	V	$I_{O} = 20 \mu A, V_{I} = V_{IL}$
Logic Low Sulput Volume	* OL		0.5	0.8	]	$I_O = 4 \text{ mA}, V_I = V_{IL}$
	S	Switching Spec	cifications			
Maximum Data Rate		100	110		Mbps	$C_L = 15 \text{ pF}$
Pulse Width	PW	10			ns	50% Points, V <sub>o</sub>
Propagation Delay Input to Output (High to Low)	$t_{ m PHL}$		12	18	ns	$C_L = 15 \text{ pF}$
Propagation Delay Input to Output (Low to High)	$t_{\rm PLH}$		12	18	ns	$C_L = 15 \text{ pF}$
Pulse Width Distortion (2)	PWD		2	3	ns	$C_L = 15 \text{ pF}$
Propagation Delay Skew (3)	$t_{PSK}$		4	6	ns	$C_L = 15 \text{ pF}$
Output Rise Time (10%-90%)	$t_{\mathrm{R}}$		2	4	ns	$C_L = 15 \text{ pF}$
Output Fall Time (10%-90%)	$t_{\rm F}$	9.5h	2	4	ns	$C_L = 15 \text{ pF}$
Common Mode Transient Immunity (Output Logic High or Logic Low) <sup>(4)</sup>	$ CM_H ,  CM_L $	20	30	0.0	kV/μs	$V_{CM} = 300 \text{ V}$
Channel-to-Channel Skew	$t_{CSK}$		2	3	ns	$C_L = 15 \text{ pF}$
Dynamic Power Consumption <sup>(6)</sup>			170	200	μA/MHz	per channel
T-Series			500	640	μA/IVIΠZ	per channer





#### 5 Volt Electrical Specifications

Electrical specifications are T<sub>min</sub> to T<sub>max</sub> unless otherwise stated.

Parameters	Symbol	Min.	Тур.	Max.	Units	<b>Test Conditions</b>
		DC Specific				
Input Quiescent Supply Voltage						
IL711	ī		10	15	μΑ	
IL712	$ m I_{DD1}$		2.5	3	mA	
Output Quiescent Supply Voltage						
IL711	$I_{\mathrm{DD2}}$		5	6	mA	
IL712	1 <sub>DD2</sub>		2.5	3	mA	
Logic Input Current	$I_{I}$	-10		10	μΑ	
Logic High Output Voltage	$V_{\mathrm{OH}}$	V <sub>DD</sub> - 0.1	$V_{ m DD}$		V	$I_{O} = -20 \mu\text{A},  V_{I} = V_{IH}$
Logic Ingli output voluge	• ОН	$0.8 \times V_{DD}$	$0.9 \times V_{DD}$		•	$I_O = -4 \text{ mA}, V_I = V_{IH}$
Logic Low Output Voltage	V <sub>OL</sub>		0	0.1	V	$I_{O} = 20 \mu A, V_{I} = V_{IL}$
Eog. 2011 output voluge			0.5	0.8	•	$I_O = 4 \text{ mA}, V_I = V_{IL}$
	S	Switching Spe	cifications			
Maximum Data Rate		100	110		Mbps	$C_L = 15 \text{ pF}$
Pulse Width	PW	10			ns	50% Points, V <sub>o</sub>
Propagation Delay Input to Output (High to Low)	$t_{ m PHL}$		10	15	ns	$C_L = 15 \text{ pF}$
Propagation Delay Input to Output (Low to High)	$t_{ m PLH}$		10	15	ns	$C_L = 15 \text{ pF}$
Pulse Width Distortion (2)	PWD		2	3	ns	$C_L = 15 \text{ pF}$
Propagation Delay Skew (3)	$t_{PSK}$		4	6	ns	$C_L = 15 \text{ pF}$
Output Rise Time (10%-90%)	$t_{R}$		1	3	ns	$C_L = 15 \text{ pF}$
Output Fall Time (10%-90%)	$t_{\mathrm{F}}$		1	3	ns	$C_L = 15 \text{ pF}$
Common Mode Transient Immunity (Output Logic High or Logic Low) <sup>(4)</sup>	$ CM_H ,  CM_L $	20	30 [2	FU.C	kV/μs	$V_{cm} = 300 \text{ V}$
Channel-to-Channel Skew	$t_{CSK}$		2	3	ns	$C_L = 15 \text{ pF}$
Dynamic Power Consumption <sup>(6)</sup> T-Series			170 500	200 640	μA/MHz	per channel

#### Notes: (Apply to both 3.3 V and 5 V specifications.)

- 1. Absolute maximum ambient operating temperature means the device will not be damaged if operated under these conditions. It does not guarantee performance.
- 2. PWD is defined as  $|t_{PHL} t_{PLH}|$ . %PWD is equal to PWD divided by pulse width.
- 3. t<sub>PSK</sub> is equal to the magnitude of the worst case difference in t<sub>PHL</sub> and / or t<sub>PLH</sub> that will be seen between devices at 25°C.
- 4.  $CM_H$  is the maximum common mode voltage slew rate that can be sustained while maintaining  $V_O > 0.8 \ V_{DD2}$ .  $CM_L$  is the maximum common mode input voltage that can be sustained while maintaining  $V_O < 0.8 \ V$ . The common mode voltage slew rates apply to both rising and falling common mode voltage edges.
- 5. Device is considered a two terminal device: pins 1-4 shorted and pins 5-8 shorted.
- 6. Dynamic power consumption numbers are calculated per channel and are supplied by the channel's input side power supply.

#### **Electrostatic Discharge Sensitivity**

This product has been tested for electrostatic sensitivity to the limits stated in the specifications. However, NVE recommends that all integrated circuits be handled with appropriate care to avoid damage. Damage caused by inappropriate handling or storage could range from performance degradation to complete failure.





### **Application Information**

#### **Dynamic Power Consumption**

IsoLoop devices achieve their low power consumption from the manner by which they transmit data across the isolation barrier. By detecting the edge transitions of the input logic signal and converting these to narrow current pulses, a magnetic field is created around the GMR Wheatstone bridge. Depending on the direction of the magnetic field, the bridge causes the output comparator to switch following the input logic signal. Since the current pulses are narrow, about 2.5 ns wide, the power consumption is independent of mark-to-space ratio and solely dependent on frequency. This has obvious advantages over optocouplers whose power consumption is heavily dependent on its on-state and frequency.

The approximate power supply current per channel is:

$$I_{IN} = 40 \text{ x} \frac{f}{f_{MAX}} \text{ x} \frac{1}{4} \text{ mA}$$

Where f =operating frequency

$$f_{MAX} = 50 \text{ MHz}$$

## **Power Supply Decoupling**

Both power supplies to these devices should be decoupled with low ESR 47 nF ceramic capacitors. For data rates in excess of 10 Mbps, use of ground planes for both GND<sub>1</sub> and GND<sub>2</sub> is highly recommended. Capacitors must be located as close as possible to the V<sub>DD</sub> pins.

#### Signal Status on Start-up and Shut Down

To minimize power dissipation, the input signals are differentiated and then latched on the output side of the isolation barrier to reconstruct the signal. This could result in an ambiguous output state depending on power up, shutdown and power loss sequencing. Therefore, the designer should consider the inclusion of an initialization signal in his start-up circuit. Initialization consists of toggling the input either high then low or low then high, depending on the desired state.

#### **Data Transmission Rates**

The reliability of a transmission system is directly related to the accuracy and quality of the transmitted digital information. For a digital system, those parameters which determine the limits of the data transmission are pulse width distortion and propagation delay skew

Propagation delay is the time taken for the signal to travel through the device. This is usually different when sending a low-to-high than when sending a high-to-low signal. This difference, or error, is called pulse width distortion (PWD) and is usually in nanoseconds. It may also be expressed as a percentage:

For example: For data rates of 12.5 Mbps

$$PWD\% = \frac{3 \text{ ns}}{80 \text{ ns}} \times 100\% = 3.75\%$$

This figure is almost **three times** better than for any available optocoupler with the same temperature range, and **two times** better than any optocoupler regardless of published temperature range. The IsoLoop range of isolators surpasses the 10% maximum PWD recommended by PROFIBUS, and will run at almost 35 Mb before reaching the 10% limit.

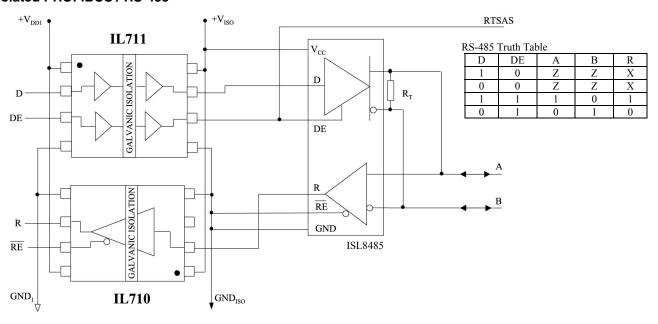
Propagation delay skew is the difference in time taken for two or more channels to propagate their signals. This becomes significant when clocking is involved since it is undesirable for the clock pulse to arrive before the data has settled. A short propagation delay skew is therefore critical, especially in high data rate parallel systems, to establish and maintain accuracy and repeatability. The IsoLoop range of isolators all have a maximum propagation delay skew of 6 ns, which is **five times** better than any optocoupler. The maximum channel-to-channel skew in the IsoLoop coupler is only 3ns, which is ten times better than any optocoupler.





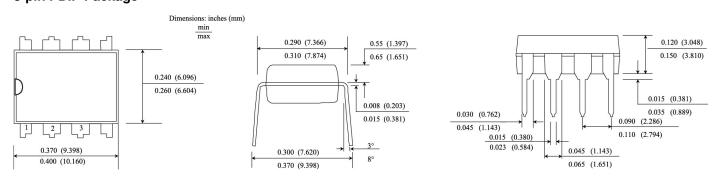
### **Application Diagrams**

#### Isolated PROFIBUS / RS-485

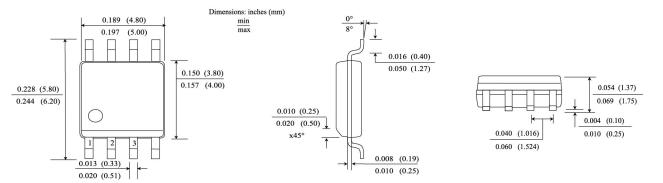


## Package Drawings, Dimensions and Specifications

## 8-pin PDIP Package



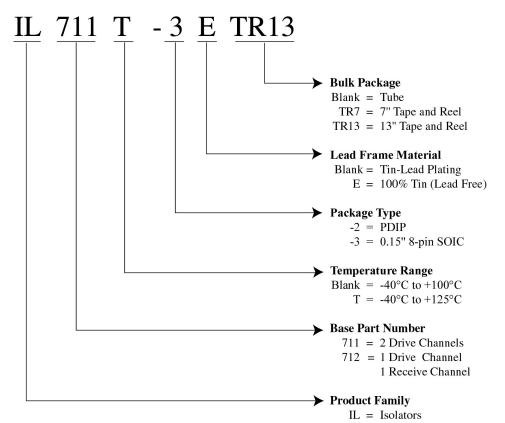
### 8-pin SOIC Package







### **Ordering Information and Valid Part Numbers**



### **Valid Part Numbers**

IL711-2	IL712-2
IL711-2E	IL712-2E
IL711T-2	IL712T-2
IL711T-2E	IL712T-2E
IL711-3	IL712-3
IL711T-3	IL712T-3
IL711-3E	IL712-3E
IIL711T-3E	IL712T-3E
All IL711-3 parts	All IL711-3 parts
are available on	are available on
tape and reel.	tape and reel.





### ISB-DS-001-IL711/12-H

### Changes

1.	Page 1:	Revision letter added.
2.	Page 1:	T-Series parts temperature information added.
3.	Page 2:	T-Series parts temperature information added to Absolute Maximum Ratings.
4.	Page 2:	T-Series parts temperature information added to Recommending Operating Conditions.
5.	Page 2:	Storage temperature changed from 175°C max. to 150°C max.
6.	Page 2:	Lead soldering temperature changed from 180°C max. to 260°C max.
7.	Page 2:	Package Power Dissipation: Test Condition added $f = 1MHz$ , $V_{DD} = 5V$ .
8.	Page 2:	IEC 61010-1 Classification: "Reinforced Insulation" added.
9.	Page 4:	3.3 Volt and 5 Volt Electrical Specifications split into separate tables.
10.	Page 5:	3.3 Volt Electrical Specifications: Dynamic Power Consumption added.
11.	Page 6:	5 Volt Electrical Specifications: Dynamic Power Consumption added.
12.	Page 9:	Ordering Information: Temperature Range Option added
13.	Page 9:	Ordering Information: 5 Volt only option removed. Valid Part Numbers IL711-2B, IL711-3B, IL711-2BE, IL711-3BE, IL712-2B, IL712-3B, IL712-2BE, and IL712-3BE removed.

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#### **About NVE**

An ISO 9001 Certified Company

NVE Corporation is a high technology components manufacturer having the unique capability to combine spintronic Giant Magnetoresistive (GMR) materials with integrated circuits to make high performance electronic components. Products include Magnetic Field Sensors, Magnetic Field Gradient Sensors (Gradiometer), Digital Magnetic Field Sensors, Digital Signal Isolators and Isolated Bus Transceivers.

NVE is a leader in GMR research and in 1994 introduced the world's first products using GMR material, a line of GMR magnetic field sensors that can be used for position, magnetic media, wheel speed and current sensing.

NVE is located in Eden Prairie, Minnesota, a suburb of Minneapolis. Please visit our Web site at www.nve.com or call (952) 829-9217 for information on products, sales or distribution.

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Specifications shown are subject to change without notice.

ISB-DS-001-IL711/12-H September 30, 2005